

**Fig. 1**

1. The present invention relates to a device for mounting a component on a substrate. The device comprises a base plate (1) and a mounting plate (2) which is mounted on the base plate. The mounting plate (2) is provided with a plurality of mounting holes (3) for mounting components. The device is characterized in that the mounting plate (2) is provided with a plurality of mounting holes (3) which are arranged in a grid pattern.

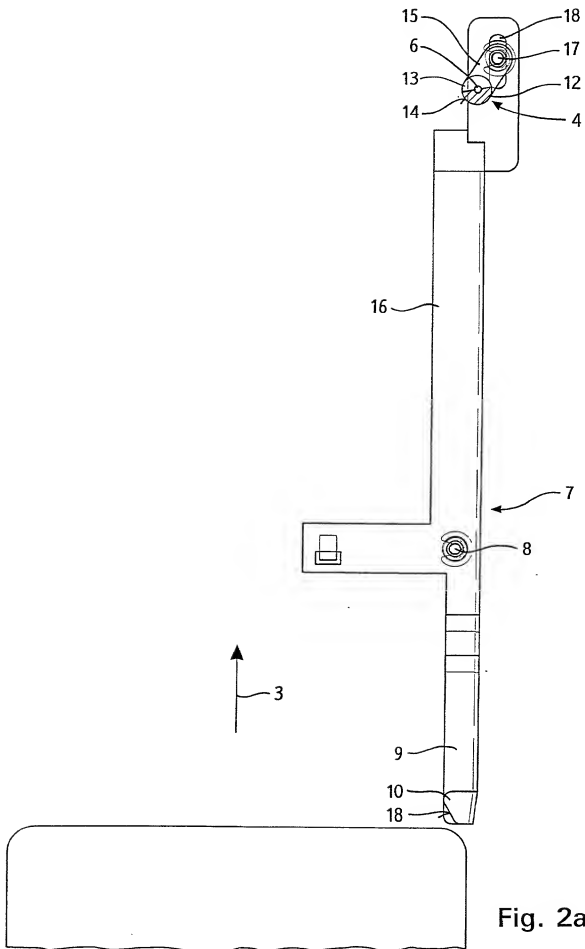
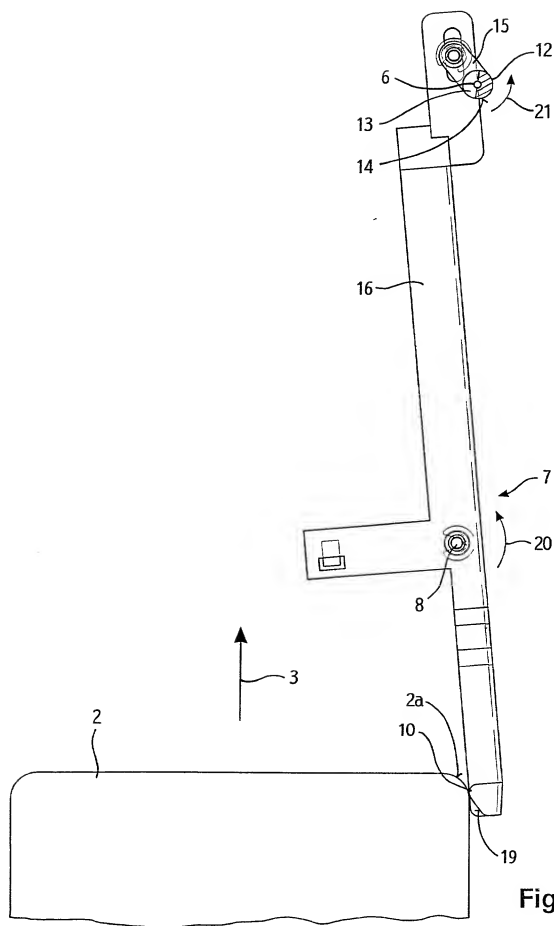
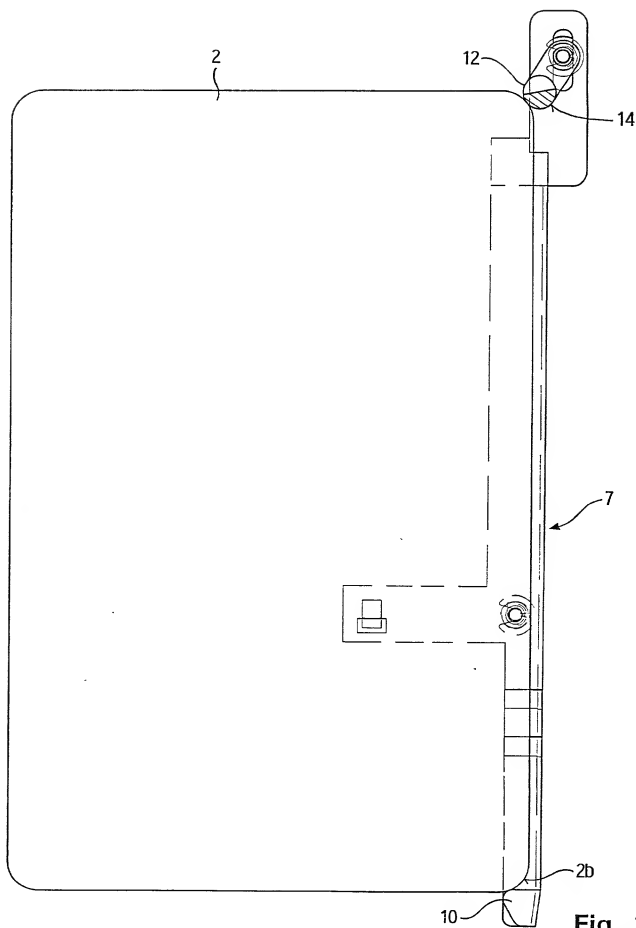


Fig. 2a





**Fig. 2c**

Fig. 3a

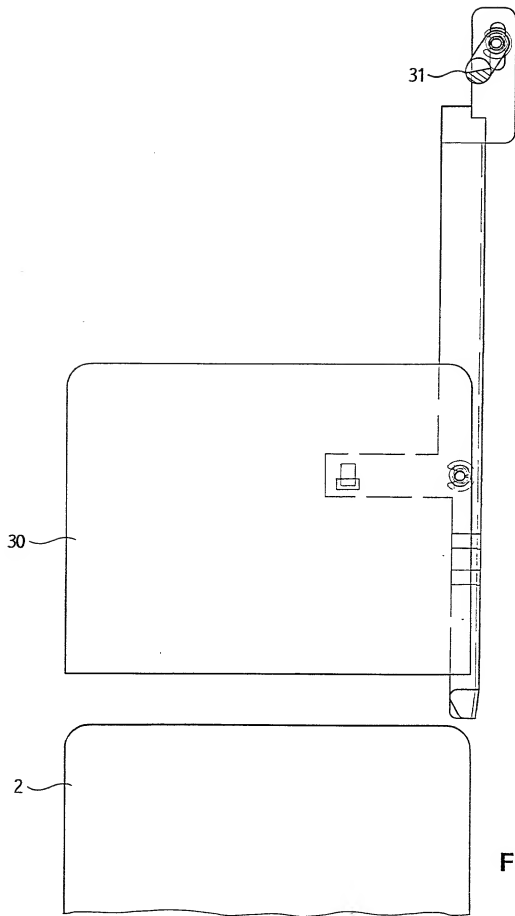
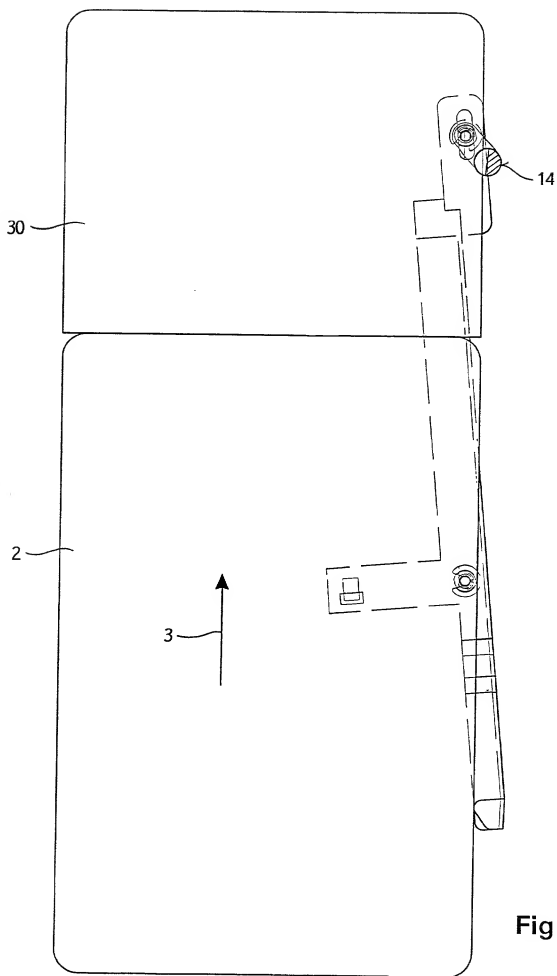


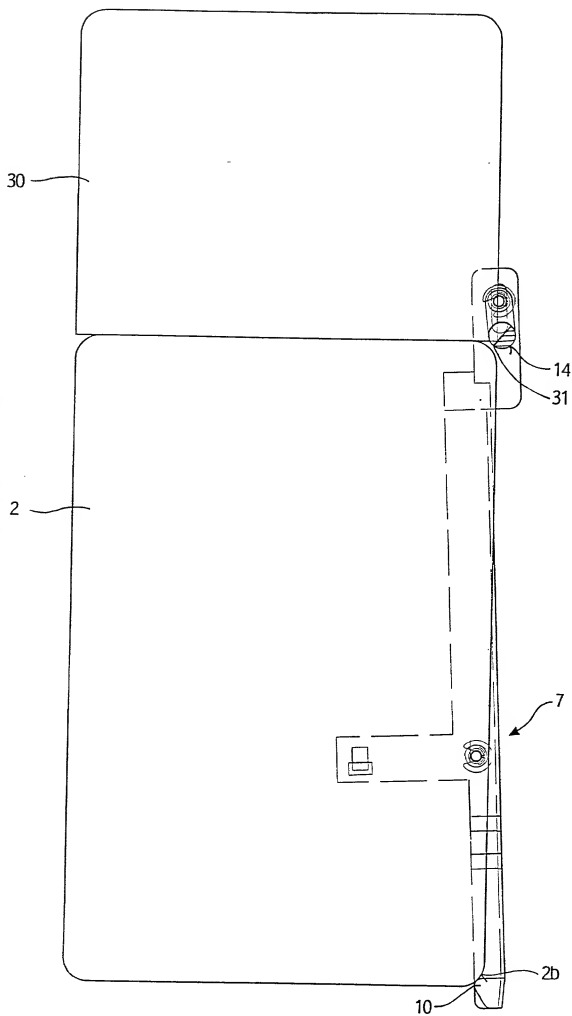
Fig. 3a

Fig. 3b  
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**Fig. 3b**

Fig. 3a  
Fig. 3b  
Fig. 3c  
Fig. 3d  
Fig. 3e  
Fig. 3f  
Fig. 3g  
Fig. 3h  
Fig. 3i  
Fig. 3j  
Fig. 3k  
Fig. 3l  
Fig. 3m  
Fig. 3n  
Fig. 3o  
Fig. 3p  
Fig. 3q  
Fig. 3r  
Fig. 3s  
Fig. 3t  
Fig. 3u  
Fig. 3v  
Fig. 3w  
Fig. 3x  
Fig. 3y  
Fig. 3z



**Fig. 3c**